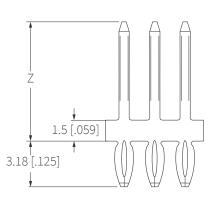


.064 mm SQUARE PRESS-FIT TERMINAL SPECIFICATIONS

| ТҮРЕ | PART NUMBER | MATERIAL | SIZE | Z LENGTH | | PCB HOLE | CARRIER TYPE | CURRENT CAPACITY | CURRENT CAPACITY |
|----------------|---------------|----------|-----------|----------|-------|----------|----------------|---------------------|---------------------|
| | | | | MM | INCH | SIZE | CARRIER IIFE | STANDARD | HI-TEMP |
| .064 mm Square | 7-V5030-025TT | Standard | .64 x .64 | 11.50 | 0.453 | А | Bottom Carrier | 8 A | 16 A |
| | 7-V5030-035TT | Standard | .64 x .64 | 8.77 | 0.345 | A | Bottom Carrier | 10 A | 21 A |
| | 7-V5030-075TT | Standard | .64 x .64 | 9.65 | 0.380 | A | Bottom Carrier | 10 A | 19 A |
| | 7-V5040-024AA | Standard | .64 x .64 | 11.50 | 0.453 | А | Side Carrier | 8 A | 16 A |
| | 7-V5040-024TT | Standard | .64 x .64 | 11.50 | 0.453 | А | Side Carrier | 8 A | 16 A |
| | 7-V5040-084TT | Standard | .64 x .64 | 13.49 | 0.531 | А | Side Carrier | 7 A | 14 A |
| | 7-V5040-094TT | Standard | .64 x .64 | 10.70 | 0.421 | А | Side Carrier | 9 A | 17 A |

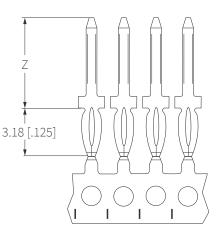
NOTE:

- Current Carrying Capacity (Current Rating) for $\Delta T = 30^{\circ}$ C Heat Rise
- Current Carrying Capacity (Current Rating) for C42520 is defined per: SAE/USCAR-2 -Revision 5 - Section 5.3.3, EIA Publication 364 - Procedure 70 thru the testing
- Current Carrying Capacities (Current Rating) for C19010 are defined using C42520 data and theoretical formula
- All current ratings must be verified during validation testing of the final assembly



Side Carrier

Bottom Carrier



PRESS-FIT PCB HOLE SIZE REQUIREMENTS

| HOLE SIZE | COMPONENT THICKNESS | FINISHED HOLE DIAMETER | DESCRIPTION | PC BOARD DIMENSIONS | | | |
|--------------|------------------------|------------------------------|--------------------------------|------------------------|--|--|--|
| | 0.64 mm | 1.05 mm | Drilled Hole | 1.15 ± 0.025 mm | | | |
| | | | Copper Plating | | | | |
| | | | Plating Thickness | 25 µm min | | | |
| Δ. | | | Hole Diameter | 1.05 ± 0.05 mm | | | |
| A | | | Finished Hole | | | | |
| | | | Tin Plating Thickness | 2 µm-8 µm | | | |
| | | | Plated Hole Diameter | 1.05 ± 0.05 mm | | | |
| | | | Precious metal Plated (Note 2) | 1.05 ± 0.05 mm | | | |

NOTE:

1. Tin thickness applies to tin-lead and lead free plating.

2. Precious metal plating types:

Immersion Au:

0.08 µm-0.13 µm [3 µin-5 µin] Gold over 3.8 µm-7.6 µm [150 µin-300 µin] Nickel

Immersion Ag:

0.2 μm-0.5 μm [8 μin -20 μin]